



SUPER FLUX LED LAMP

### **Features**

- High current operation for greater luminous output
- Low power consumption and thermal resistance
- Can be used with automatic insertion equipment
- RoHS Compliant





## **Benefits:**

- •Rugged design allows for easy maintenance
- •Robust package for optimum reliability

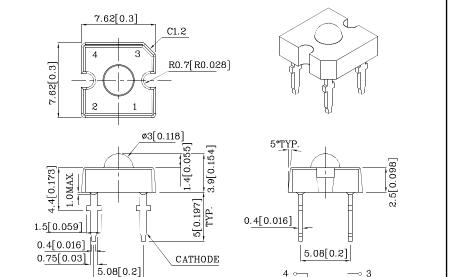
# **Typical Applications:**

- •Automotive side markers
- •Gaming and entertainment lighting
- •Signs and road hazard indicators



# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# **Package Schematics**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (T <sub>A</sub> =25°C)	Blue (InGaN)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V	
DC Forward Current	$I_{\mathrm{F}}$	30	mA	
Power Dissipation	PD	135	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-55 ~ +85	-0	
Electrostatic Discharge Thres (HBM)	250	V		
Lead Solder Temperature [1.5mm Below Seating Plane.][1]		260°C For 5 Seconds		

Operating Characteristics $(T_A=25^{\circ}C)$	Blue (InGaN)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =30mA)	$V_{\mathrm{F}}$	3.5	V
Forward Voltage (Max.) (I <sub>F</sub> =30mA)	$V_{\mathrm{F}}$	4.5	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_{\mathrm{R}}$	50	uA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =30mA)	λР	465*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I <sub>F</sub> =30mA)	λD	470*	nm
Spectral Line Full Width At Half Maximum (Typ.) (I <sub>F</sub> =30mA)	$\triangle \lambda$	22	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	100	pF
Thermal Resistance (Typ.)	Rθj-pin	180	°C/W

- 1.No Reflow soldering.
- 2.A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} Luminous \ Intensity \\ CIE127-2007* \\ (I_F=30mA) \ cd \end{array}$		Wavelength CIE127-2007* λP nm	Viewing Angle 20 1/2
				main tree	tren		

				min.	typ.	typ.		
XSFBB983W	Blue	InGaN	Water Clear	0.9*	1.195*	1.3*	465*	40°

- 1.Luminous intensity is measured with an integrating sphere after the device has stabilized.
- $2.0 \frac{1}{2}$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 3.LEDs are binned according to their Luminous intensity.
- \* Luminous intensity / luminous flux value and wavelength are in accordance with CIE127-2007 standards.

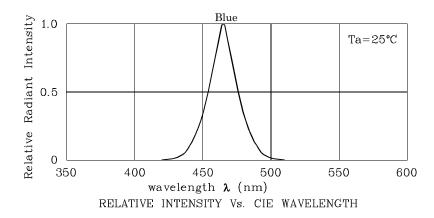
Oct 10,2016 XDSB5191 V5-Z Layout: Maggie L.

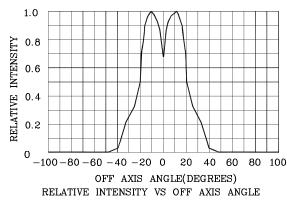


# Part Number: XSFBB983W

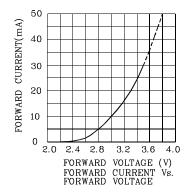
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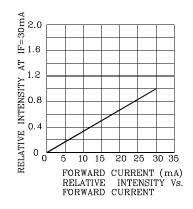


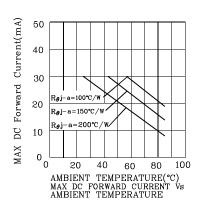




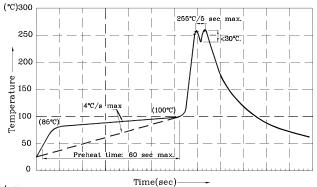
## Blue







Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



- Roces.

  1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C  $\sim$  255°C for 3 sec (5 sec max)
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C. 4. Fixtures should not incur stress on the component when mounting and during soldering process.
  5. SAC 305 solder alloy is recommended.
  6. No more than one wave soldering pass.

## Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

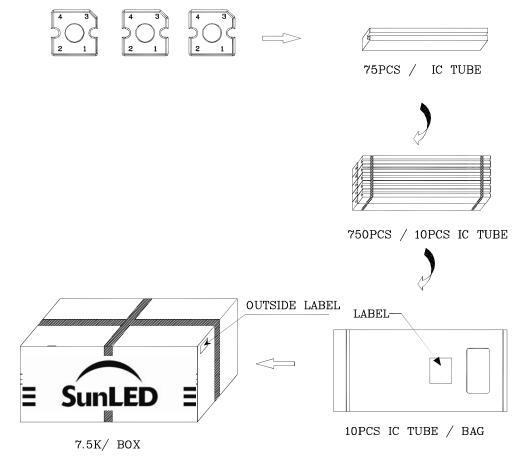
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

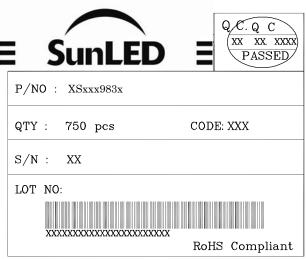
Note: Accuracy may depend on the sorting parameters.



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# PACKING & LABEL SPECIFICATIONS





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- 6. Additional technical notes are available at <a href="http://www.SunLEDusa.com/TechnicalNotes.asp">http://www.SunLEDusa.com/TechnicalNotes.asp</a>

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